



6W+6W STEREO AMPLIFIER WITH MUTE & ST-BY

- WIDE SUPPLY VOLTAGE RANGE UP TO +18V
- 6+6W @THD = 10%, $R_L = 8\Omega$, $V_S = \pm 10V$
- NO POP AT TURN-ON/OFF
- MUTE (POP FREE)
- STANDARD BY FEATURE (LOW I_q)
- SHORT CIRCUIT PROTECTION TO GND
- THERMAL OVERLOAD PROTECTION
- CLIPWATT 11 PACKAGE



The TDA7499SA is class AB power amplifier assembled in the @ Clipwatt 11 package, specially designed for high quality sound application as Hi-Fi

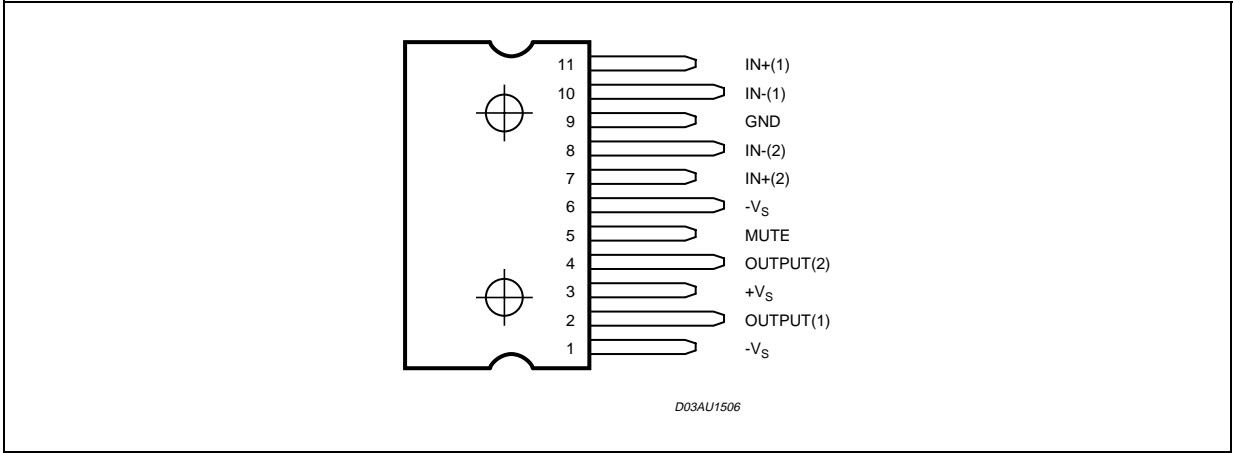
The TDA7499SA is pin to pin compatible with TDA7269, TDA7269A, TDA7269SA, TDA7269ASA, TDA7265, TDA7499.

TDA7499SA

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|----------------|--|------------|--------------------|
| V_S | DC Supply Voltage | ± 20 | V |
| I_O | Output Power Current (internally limited) | 2.5 | A |
| P_{tot} | Total Power Dissipation ($T_{amb} = 70^{\circ}\text{C}$) | 20 | W |
| T_{amb} | Ambient Operating Temperature (1) | 0 to 70 | $^{\circ}\text{C}$ |
| T_{stg}, T_j | Storage and Junction Temperature | -40 to 150 | $^{\circ}\text{C}$ |

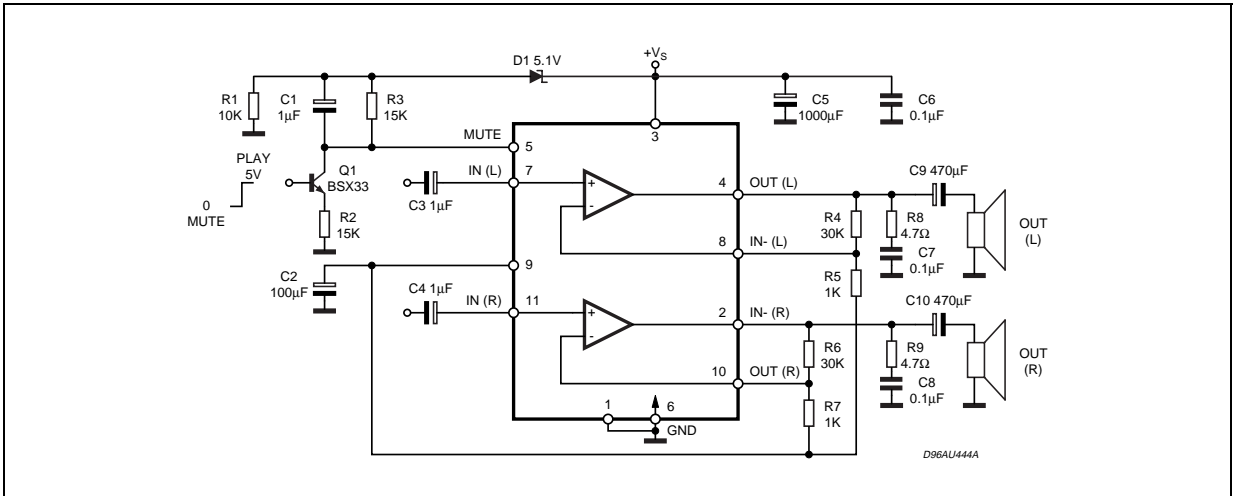
PIN CONNECTION (Top view)



THERMAL DATA

| Symbol | Parameter | Value | Unit |
|------------------|-------------------------------------|-----------|----------------------|
| $R_{th\ j-case}$ | Thermal Resistance Junction-case | max = 3.9 | $^{\circ}\text{C/W}$ |
| $R_{th\ j-amb}$ | Thermal Resistance Junction-ambient | max = 48 | $^{\circ}\text{C/W}$ |

Figure 1. Single Supply Application



ELECTRICAL CHARACTERISTICS (Refer to the test circuit $V_S = \pm 10V$; $R_S = 50\Omega$; $G_V = 30dB$, $f = 1KHz$; $T_{amb} = 25^\circ C$, unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Unit |
|--|--|--|---------|----------|----------|--------------------|
| V_S | Supply Voltage Range | $R_L = 8\Omega$ | ± 5 | | ± 18 | V |
| | | $R_L = 4\Omega$; | ± 5 | | ± 12 | V |
| I_q | Total Quiescent Current | | | 50 | 90 | mA |
| V_{OS} | Input Offset Voltage | | -25 | | 25 | mV |
| I_b | Output Bias Current | | | 500 | | nA |
| P_O | Output Power | THD = 10%; $R_L = 8\Omega$; $V_S = \pm 8.5V$; $R_L = 4\Omega$; | | 6 6 | | W W |
| | | THD = 1%; $R_L = 8\Omega$; $V_S = \pm 8.5V$; $R_L = 4\Omega$; | | 5 5 | | W W |
| THD | Total Harmonic Distortion | $R_L = 8\Omega$; $P_O = 1W$; $f = 1KHz$; | | 0.03 | | % |
| | | $R_L = 8\Omega$; $V_S = \pm 10V$; $P_O = 0.1$ to $5W$; $f = 100Hz$ to $15KHz$; | | 0.2 | 0.5 | % |
| | | $R_L = 4\Omega$; $P_O = 1W$; $f = 1KHz$; | | 0.02 | | % |
| | | $R_L = 4\Omega$; $V_S = \pm 10V$; $P_O = 0.1$ to $2W$; $f = 100Hz$ to $15KHz$; | | 0.2 | 1 | % |
| C_T | Cross Talk | $f = 1KHz$; $f = 10KHz$; | 50 | 70 60 | | dB dB |
| SR | Slew Rate | | 6.5 | 10 | | V/ μs |
| G_{OL} | Open Loop Voltage Gain | | | 80 | | dB |
| e_N | Total Output Noise | A Curve $f = 20Hz$ to $22KHz$ | | 3 4 | 8 | μV μV |
| R_i | Input Resistance | | 15 | 20 | | K Ω |
| SVR | Supply Voltage Rejection (each channel) | $f = 100Hz$; $V_R = 0.5V$ | | 60 | | dB |
| T_j | Thermal Shut-down Junction Temperature | | | 145 | | $^\circ C$ |
| MUTE & INPUT SELECTION FUNCTIONS | | | | | | |
| V_{MUTE} | Mute /Play threshold | | -7 | -6 | -5 | V |
| A_{MUTE} | Mute Attenuation | | 60 | 70 | | dB |
| STAND-BY FUNCTIONS [ref: +V_S] (only for Split Supply) | | | | | | |
| V_{ST-BY} | Stand-by Mute threshold | | -3.5 | -2.5 | -0.5 | V |
| A_{ST-BY} | Stand-by Attenuation | | | 110 | | dB |
| I_{qST-BY} | Quiescent Current @ Stand-by | | | 3 | 6 | mA |

MUTE STAND-BY FUNCTION

The pin 5 (MUTE/STAND-BY) controls the amplifier status by two different thresholds, referred to $+V_S$.

- When V_{pin5} higher than $+V_S - 2.5V$ the amplifier is in Stand-by mode and the final stage generators are off.
- When V_{pin5} between $+V_S - 2.5V$ and $V_S - 6V$ the final stage generators are switched on and the amplifier is in mute mode.
- When V_{pin5} lower than $+V_S - 6V$ the amplifier is play mode.

Figure 2.

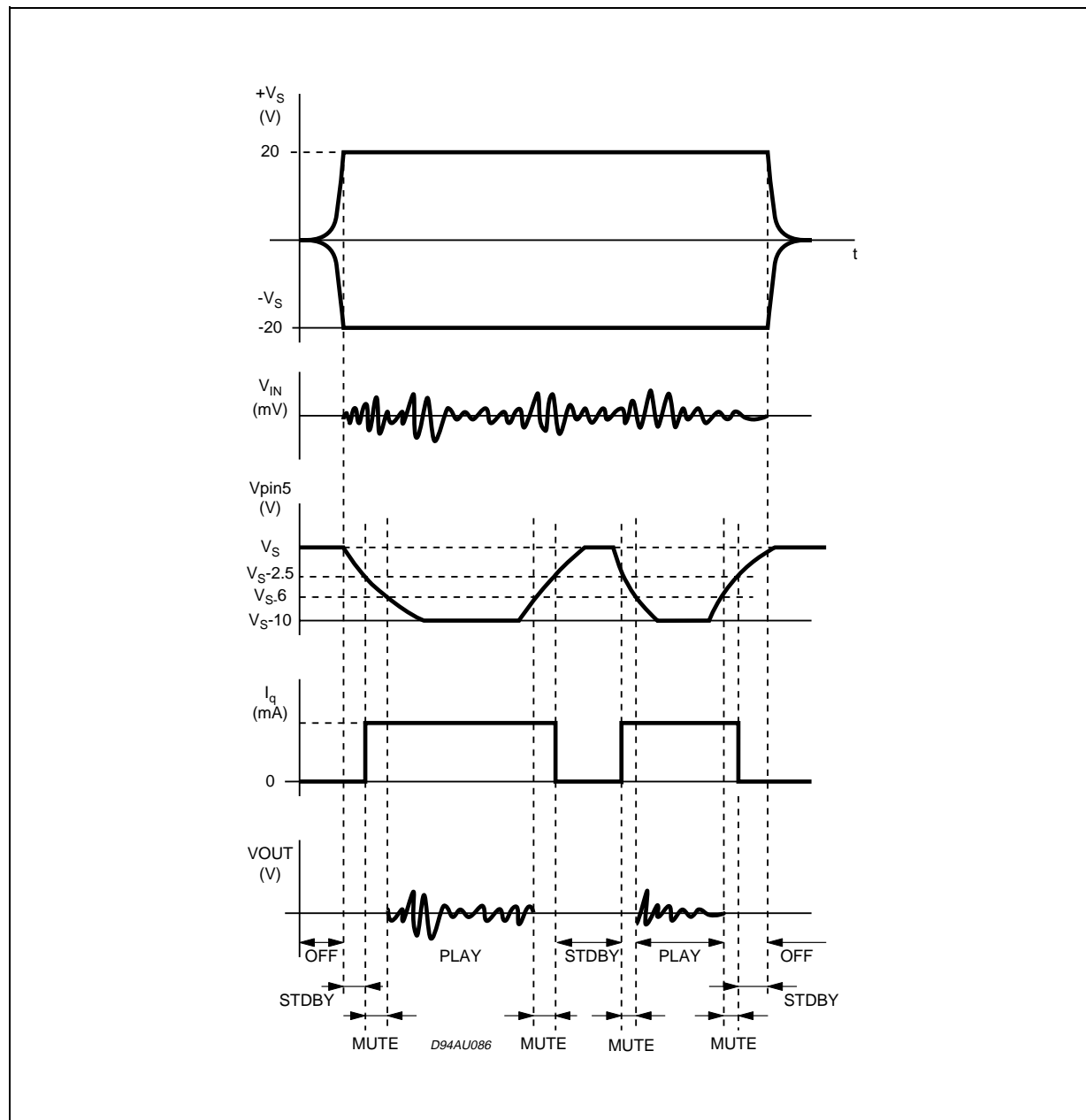
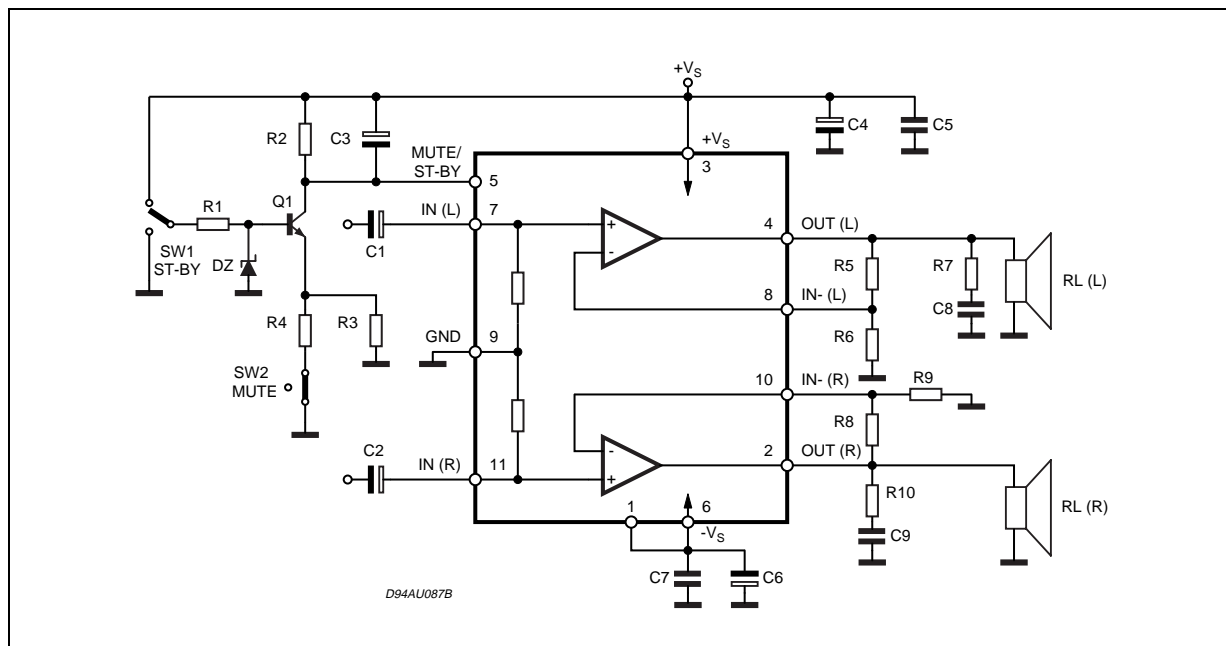


Figure 3. Test and Application Circuit (Stereo Configuration)

**APPLICATION SUGGESTIONS** (Demo Board Schematic)

The recommended values of the external components are those shown the demoboard schematic different values can be used, the following table can help the designer.

| COMPONENT | SUGGESTION VALUE | PURPOSE | LARGER THAN RECOMMENDED VALUE | SMALLER THAN RECOMMENDED VALUE |
|-----------|------------------|------------------------------|--------------------------------------|--------------------------------------|
| R1 | 10K Ω | Mute Circuit | Increase of Dz Biasing Current | |
| R2 | 15K Ω | Mute Circuit | V _{pin #5} Shifted Downward | V _{pin #5} Shifted Upward |
| R3 | 18K Ω | Mute Circuit | V _{pin #5} Shifted Upward | V _{pin #5} Shifted Downward |
| R4 | 15K Ω | Mute Circuit | V _{pin #5} Shifted Upward | V _{pin #5} Shifted Downward |
| R5, R8 | 18K Ω | Closed Loop Gain Setting (*) | Increase of Gain | |
| R6, R9 | 560K Ω | | Decrease of Gain | |
| R7, R10 | 4.7K Ω | Frequency Stability | Danger of Oscillations | Danger of Oscillations |
| C1, C2 | 1 μ F | Input DC Decoupling | | Higher low frequency cutoff |
| C3 | 1 μ F | St-By/Mute Time Constant | Larger On/Off Time | Smaller On/Off Time |
| C4, C6 | 1000 μ F | Supply Voltage Bypass | | Danger of Oscillations |
| C5, C7 | 0.1 μ F | Supply Voltage Bypass | | Danger of Oscillations |
| C8, C9 | 0.1 μ F | Frequency Stability | | |
| Dz | 5.1V | Mute Circuit | | |

(*) Closed loop gain has to be ≥ 25 dB

PC Board

Figure 4. Evaluation Board Top Layer Layout

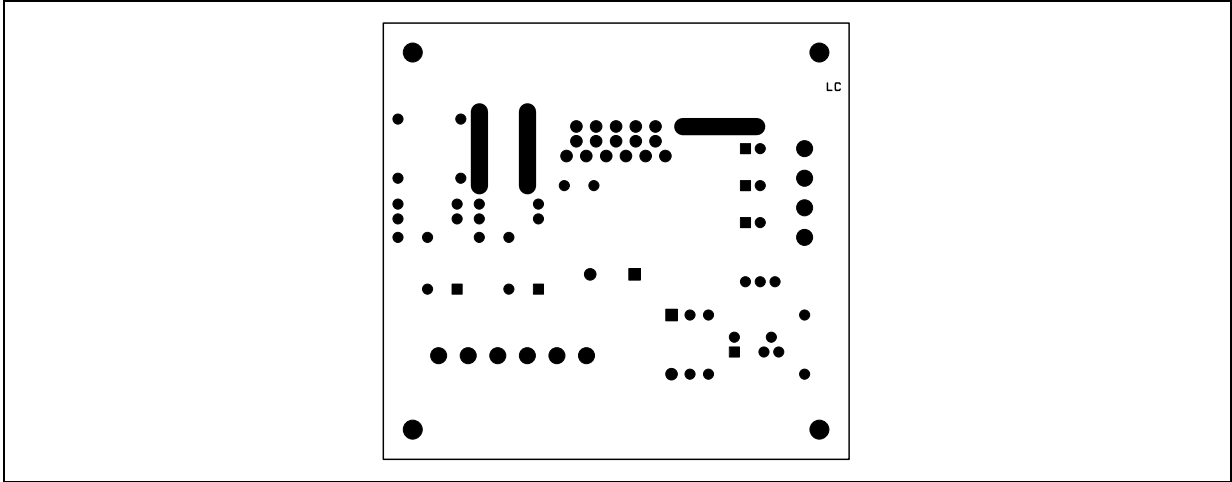


Figure 5. Evaluation Board Bottom Layer Layout

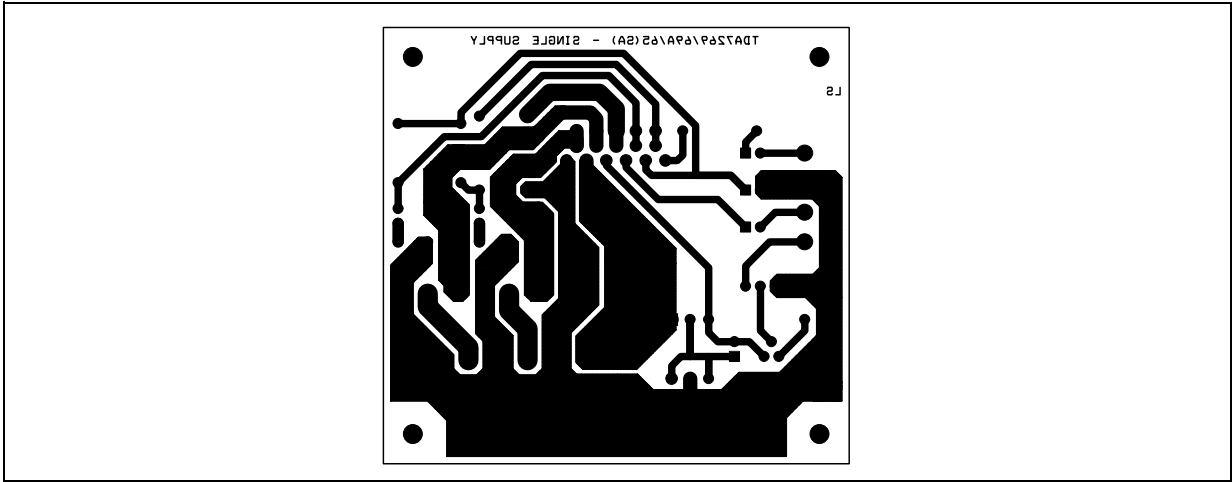
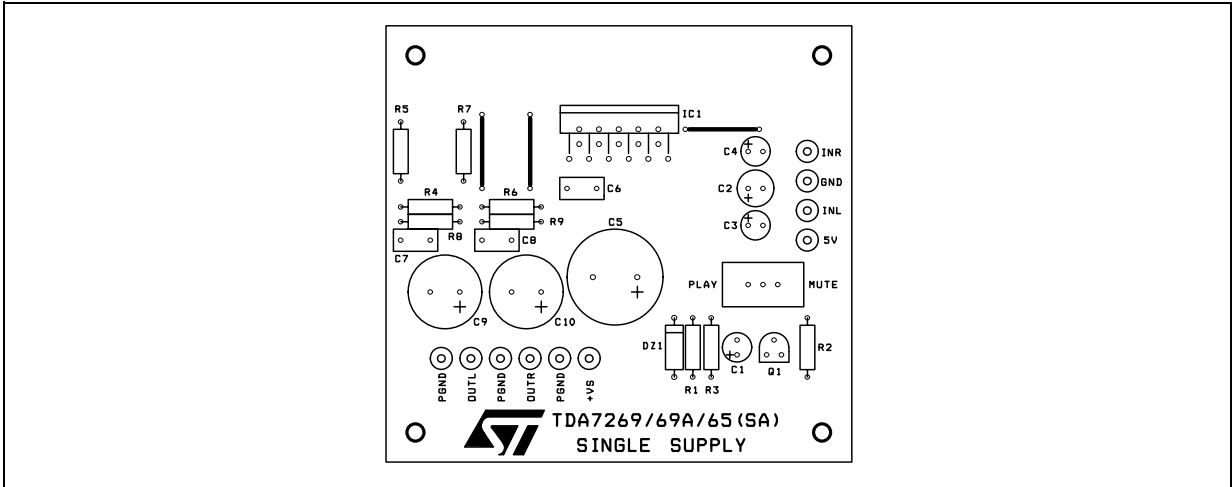


Figure 6. Component Layout



HEAT SINK DIMENSIONING:

In order to avoid the thermal protection intervention, that is placed approximatively at $T_j = 150^\circ\text{C}$, it is important the dimensioning of the Heat Sink R_{Th} ($^\circ\text{C}/\text{W}$).

The parameters that influence the dimensioning are:

- Maximum dissipated power for the device (P_{dmax})
- Max thermal resistance Junction to case ($R_{Th\ j-c}$)
- Max. ambient temperature $T_{amb\ max}$
- Quiescent current I_q (mA)

Example:

$V_{CC} = \pm 10\text{V}$, $R_{load} = 80\text{ohm}$, $R_{Th\ j-c} = 3.9\ ^\circ\text{C}/\text{W}$, $T_{amb\ max} = 50^\circ\text{C}$

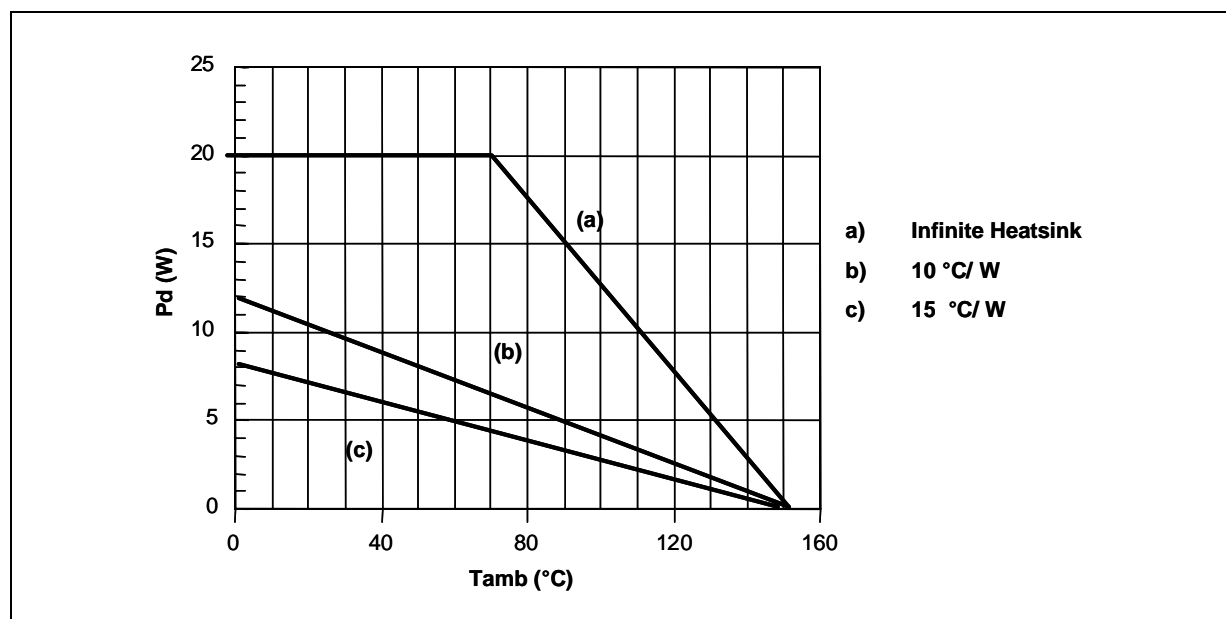
$$P_{dmax} = (N^\circ \text{ channels}) \cdot \frac{2V_{cc}^2}{\Pi^2 \cdot R_{load}} + I_q \cdot V_{cc}$$

$$P_{dmax} = 2 \cdot (2.5) + 0.8 = 6\text{W}$$

$$(\text{Heat Sink}) R_{Th\ c-a} = \frac{150 - T_{amb\ max}}{P_{d\ max}} - R_{Th\ j-c} = \frac{150 - 50}{6} - 3.9 = 12.7^\circ\text{C}/\text{W}$$

In figure 7 is shown the Power derating curve for the device.

Figure 7. Power derating curve



Clipwatt Assembling Suggestions

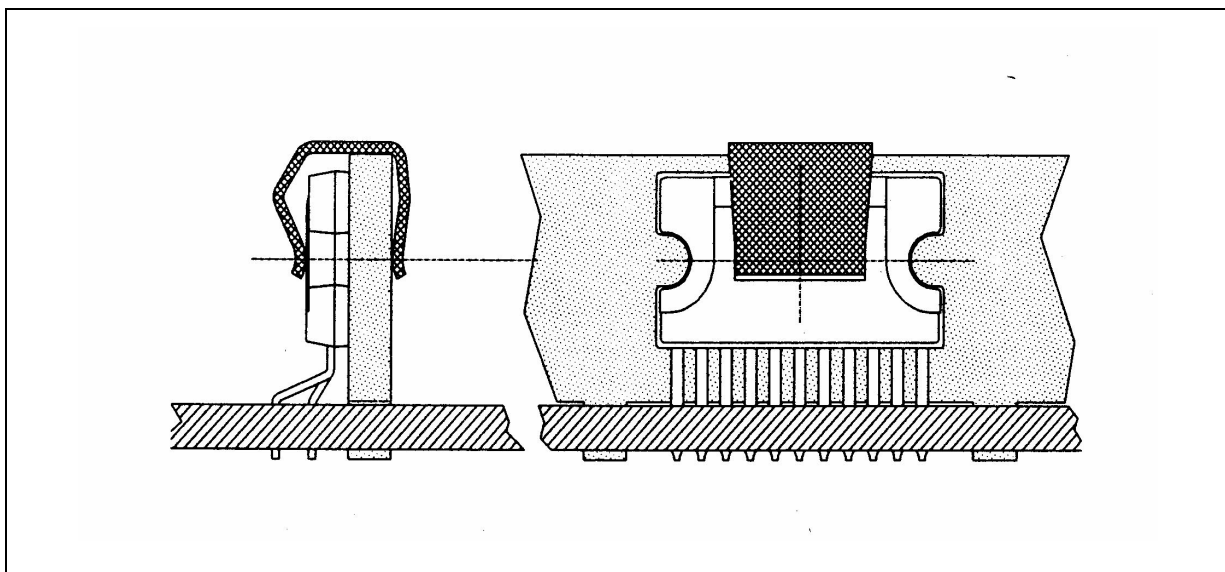
The suggested mounting method of Clipwatt on external heat sink, requires the use of a clip placed as much as possible in the plastic body center, as indicated in the example of figure 8.

A thermal grease can be used in order to reduce the additional thermal resistance of the contact between package and heatsink.

A pressing force of 7 - 10 Kg gives a good contact and the clip must be designed in order to avoid a maximum contact pressure of 15 Kg/mm² between it and the plastic body case.

As example, if a 15Kg force is applied by the clip on the package, the clip must have a contact area of 1mm² at least.

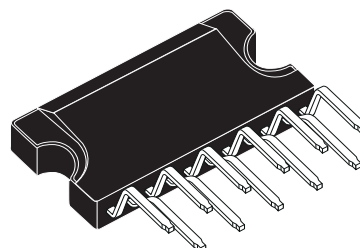
Figure 8. Example of right placement of the clip



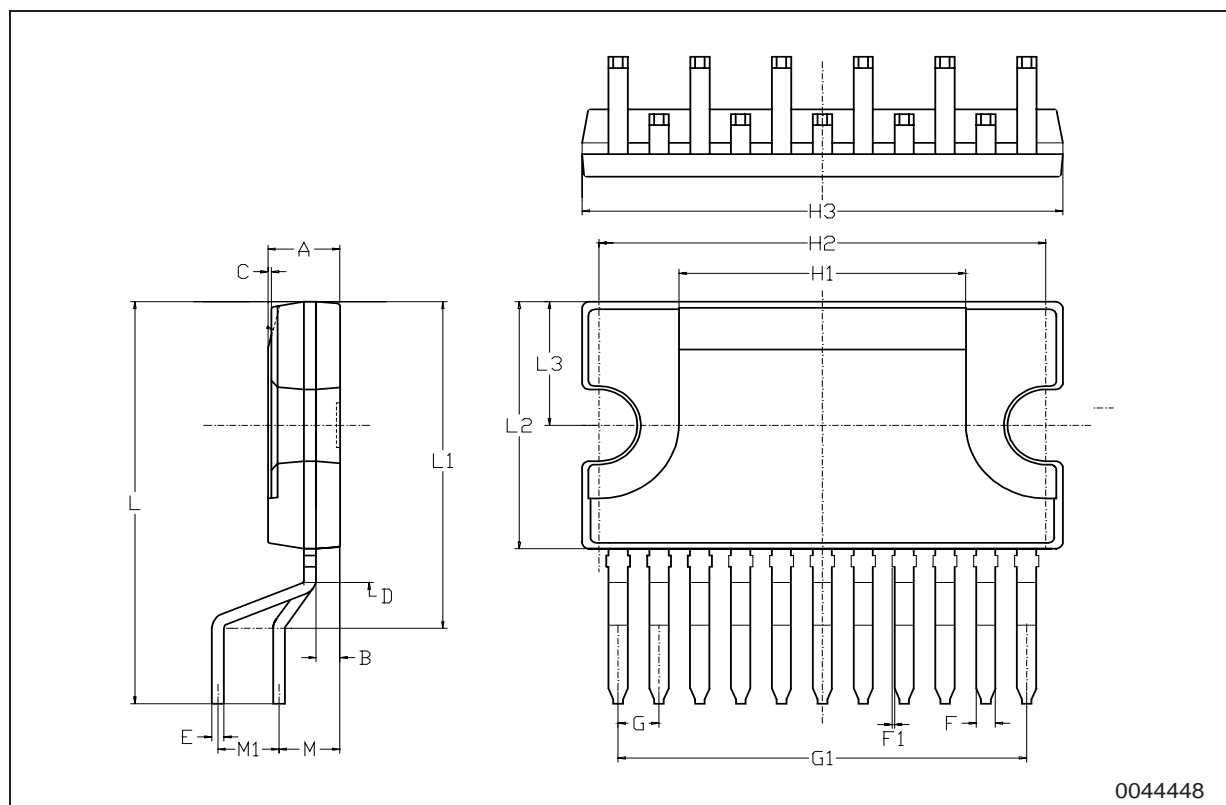
| DIM. | mm | | | inch | | |
|------|-------|-------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | | | 3.2 | | | 0.126 |
| B | | | 1.05 | | | 0.041 |
| C | | 0.15 | | | 0.006 | |
| D | | 1.5 | | | 0.059 | |
| E | 0.49 | | 0.55 | 0.019 | | 0.002 |
| F | 0.77 | 0.8 | 0.88 | 0.030 | 0.031 | 0.035 |
| F1 | | | 0.15 | | | 0.006 |
| G | 1.57 | 1.7 | 1.83 | 0.062 | 0.067 | 0.072 |
| G1 | 16.87 | 17 | 17.13 | 0.664 | 0.669 | 0.674 |
| H1 | | 12 | | | 0.480 | |
| H2 | | 18.6 | | | 0.732 | |
| H3 | 19.85 | | | 0.781 | | |
| L | | 17.9 | | | 0.700 | |
| L1 | | 14.55 | | | 0.580 | |
| L2 | 10.7 | 11 | 11.2 | 0.421 | 0.433 | 0.441 |
| L3 | | 5.5 | | | 0.217 | |
| M | | 2.54 | | | 0.100 | |
| M1 | | 2.54 | | | 0.100 | |

OUTLINE AND MECHANICAL DATA

Weight: 1.80gr



Clipwatt11



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